

*Image*  
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

2822

Applicant: Qing Ma

Title: METHOD OF FABRICATING AN INTEGRATED CIRCUIT THAT SEALS A MEMS  
DEVICE WITHIN A CAVITY

Docket No.: 884.591US1

Filed: November 2, 2001

Examiner: Jamie L. Brophy

Serial No.: 10/005667

Due Date: April 30, 2004

Group Art Unit: 2822



MS Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

☒ A return postcard.

☒ An Amendment and Response Under 37 C.F.R. 1.111 (7 Pages).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
Customer Number 21186

By: Ann M. McCrackin  
Atty: Ann M. McCrackin  
Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 30 day of March, 2004.

Anne M. Richards

\_\_\_\_\_  
Name

Anne M. Richards  
\_\_\_\_\_  
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
(GENERAL)



**EXPEDITED PROCEDURE – EXAMINING GROUP 2822**

**S/N 10/005667**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Qing Ma	Examiner:	Jamie L. Brophy
Serial No.:	10/005667	Group Art Unit:	2822
Filed:	November 2, 2001	Docket No.:	884.591US1
Title:	METHOD OF FABRICATING AN INTEGRATED CIRCUIT HAVING A MEMS DEVICE		
Assignee:	Intel Corporation		

---

**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

MS Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on January 30, 2004. Please amend the above-identified patent application as follows.